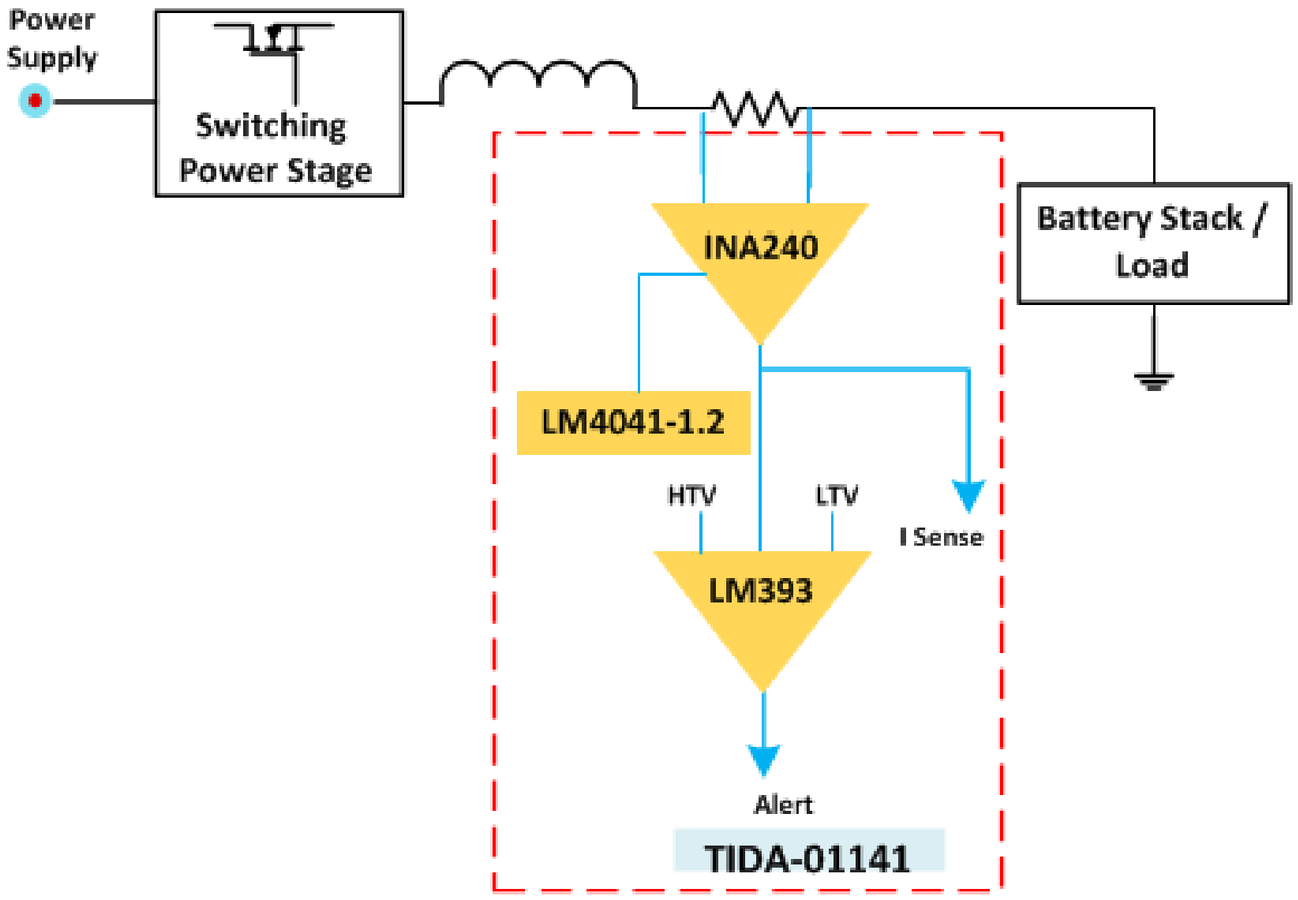
Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



Orderable: N/A	Designed for: Public Release	Mod. Date: 12/8/2016
TID #: TIDA-01141	Project Title: Bi-Directional High Side Current Sensing	
Number: TIDA-01141 Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: Ramkumar S	File: TIDA-01141_CoverSheet.SchDoc	Size: B
Engineer: Ramkumar S	Contact: http://www.ti.com/support	

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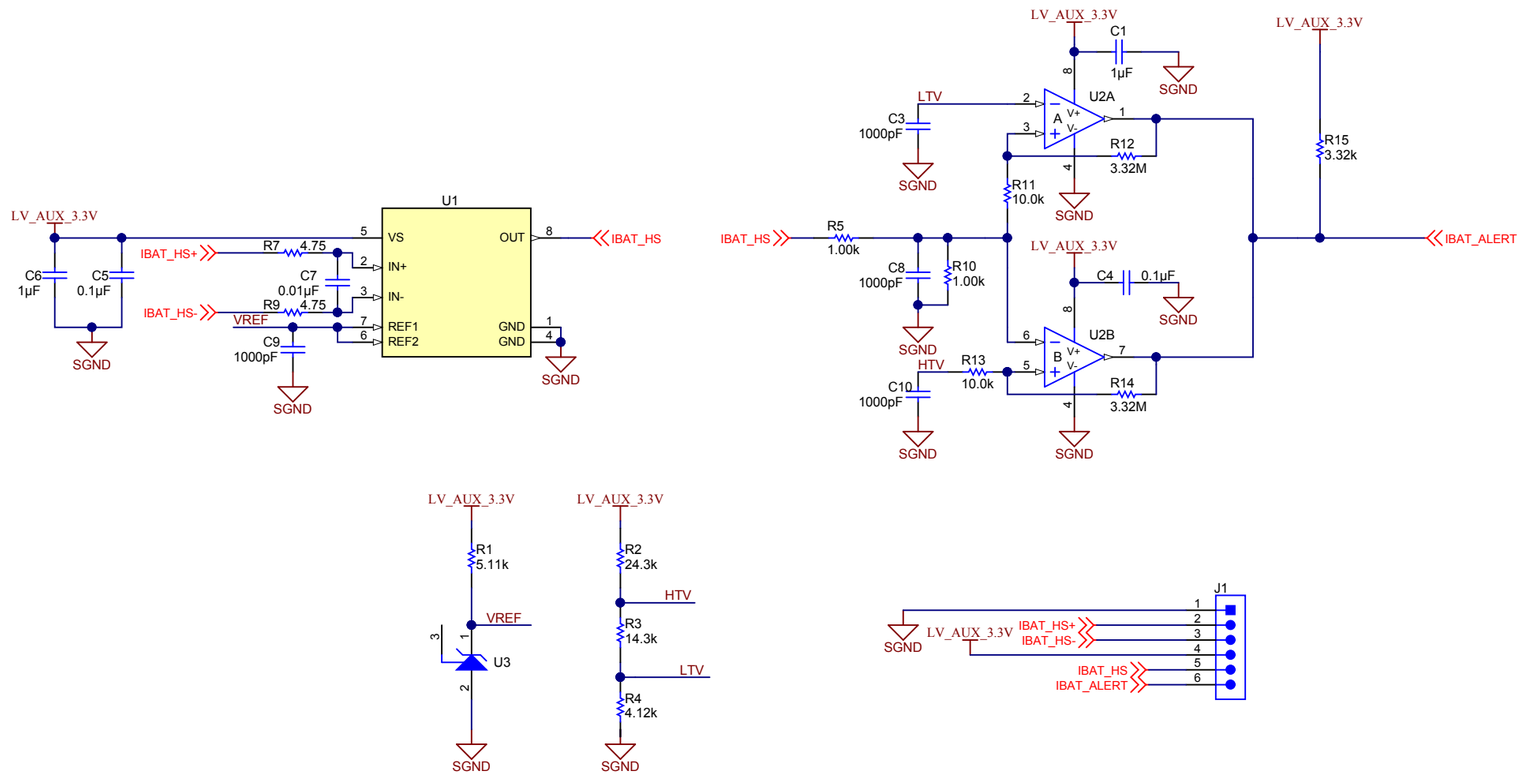

Orderable: N/A	Designed for: Public Release	Mod. Date: 12/8/2016
TID #: TIDA-01141	Project Title: Bi-Directional High Side Current Sensing	
Number: TIDA-01141 Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Ramkumar S	File: TIDA-01141_Sheet1.SchDoc	Size: B
Engineer: Ramkumar S	Contact: http://www.ti.com/support	

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PCB Number: TIDA-01141
PCB Rev: E1

PCB
LOGO
Texas Instruments

PCB
LOGO
Pb-Free Symbol


LOGO4

PCB
LOGO
Logo3

You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table

Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 9/7/2016
TID #: TIDA-01141	Project Title: Bi-Directional High Side Current Sensing	
Number: TIDA-01141 Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3
Drawn By:	File: TIDA-01141_Hardware.SchDoc	Size: B
Engineer: Ramkumar S	Contact: http://www.ti.com/support	

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